

# EVVOSEMI<sup>®</sup>

THINK CHANGE DO



ESD



TVS



MOS



LDO



Diode



Sensor



DC-DC

## Product Specification

▶ Domestic	Part Number	IRFP250N
▶ Overseas	Part Number	IRFP250N
▶ Equivalent	Part Number	IRFP250N

EV is the abbreviation of name EVVO

半导体分立器件 semiconductor discrete devices

# IRFP250N

## 一、主要参数 (Main Parameters):

功率 VDMOS 场效应晶体管,  $V_{DSX}$ : 200V,  $I_D$ : 30A,  $P_{tot}$ : 210W

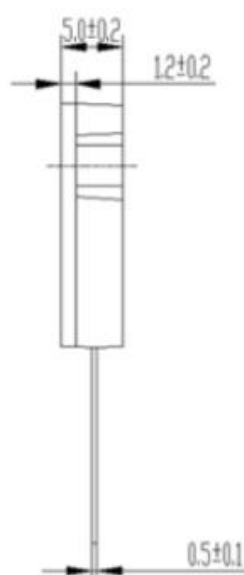
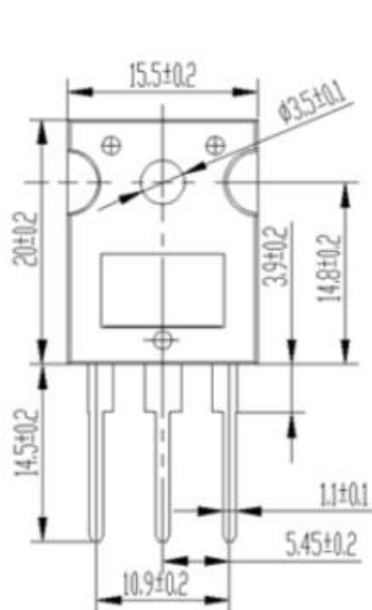
## 二、产品特性 (Features):

1)快速切换      2)频率特性优      3)RoHs 产品

## 三、用途 (Applications):

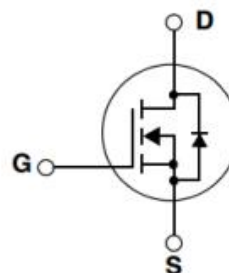
1)开关电源    2)其它电子电路

## 四、外型尺寸 (Package and outline):



1.Gate  
2.Drain  
3.Source

# T0-247



五、最大极限值 (Absolute Ratings): ( $T_c=25^{\circ}\text{C}$ )

参数名称 Description	符 号 Symbol	规范值 Value	单 位 Unit
最高漏源电压	$V_{DSX}$	200	V
连续漏极电流 $T_c=25^{\circ}\text{C}$	$I_D$	30	A
脉冲漏极电流	$I_{DM}$	120	A
栅 源 电 压	$V_{GS}$	$\pm 20$	V
耗散功率 $T_c=25^{\circ}\text{C}$	$P_{tot}$	210	W
结 温	$T_j$	150	$^{\circ}\text{C}$

## 六、电特性 (Electrical Characteristic):

参数名称 Description	符 号 Symbol	测试条件 Tests Conditions	最小值 Value(min)	典型值 Value(typ)	最大值 Value(max)	单 位 Unit
漏源反向电压	V <sub>DS</sub>	V <sub>GS</sub> =0V， I <sub>D</sub> =250 μ A	200			V
通 态 电 阻	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V， I <sub>D</sub> =18A			0.18	Ω
阈 值 电 压	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> ， I <sub>D</sub> =250 μ A	2.0	3.4	4.0	V
源漏正向压降	V <sub>SD</sub>	V <sub>GS</sub> =0V， I <sub>DS</sub> =18A			1.5	V
漏源漏电流	I <sub>DSS</sub>	V <sub>DS</sub> =200V， V <sub>GS</sub> =0V			1	uA
源栅漏电流	I <sub>GSS(F)</sub>	V <sub>GS</sub> =+30V			100	n A
源栅漏电流	I <sub>GSS(R)</sub>	V <sub>GS</sub> =-30V			-100	n A
输 入 电 容	C <sub>iss</sub>	V <sub>GS</sub> =0V， V <sub>DS</sub> =25V f=1.0MHz		1140		pF
输 出 电 容	C <sub>oss</sub>			180		pF
反向传输电容	C <sub>rss</sub>			25		pF
a: 脉冲测试 tp≤300 μ S， δ ≤2%						

## 七、注意事项 (Note):

- 1.在应用设计时,要使器件工作在安全区,不要超过器件的最大极限值,否则会影响整机的可靠性。
- 2.使用中应避免产生过流、过压和过热,必须采取有效的保护措施。
- 3.使用时,请将器件平整地安装在散热片上,请尽量缩小安装孔,并在安装面均匀涂上导热硅脂,同时核对散热片的厚度和面积是否标准,以免影响散热效果。
- 4.在安装时,请注意减少机械应力的产生,由于气动螺丝刀易产生较大冲击,安装螺丝请使用电动螺丝刀,电动螺丝刀扭矩不大于 7KG • cm,以避免由此引起的产品失效。
- 5.安装在 PCB 板上的器件易受焊槽中流动的焊剂或手工焊接高温影响。距离器件主体 1.5mm 处,焊接条件为 260℃不超过 8 秒,280℃不超过 2.5 秒,请尽可能在短时间内完成焊接。
- 6.产品入库后请尽快使用,产品储存温度为+5℃~+35℃,湿度为 40%~75%,应避免产品放置于高温、高湿或温度和湿度剧烈变化的场所,避免储存在多尘或有害气体和各种射线的场所,避免阳光直射,建议三个月内使用完毕。
- 7.使用时应对本产品进行质量检测,如有问题三天内告知本公司,公司承诺 24 小时内提供解决方案。
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